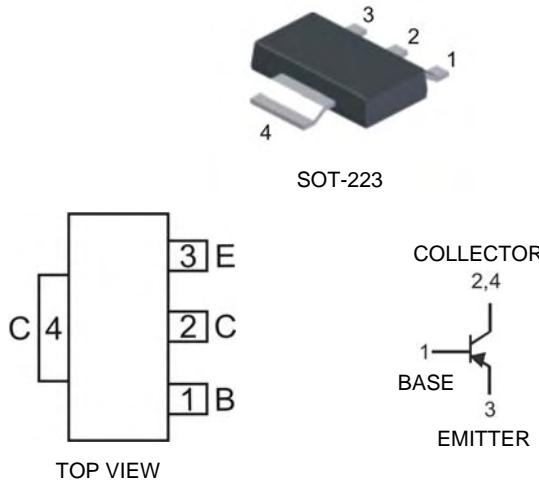


Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (DZT851)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)**
- "Green" Device (Note 2)

Mechanical Data

- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish - Matte Tin annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.115 grams (approximate)



Maximum Ratings

$\text{@T}_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-100	V
Collector-Emitter Voltage	V_{CEO}	-60	V
Emitter-Base Voltage	V_{EBO}	-6	V
Continuous Collector Current	I_C	-5	A
Power Dissipation	P_{tot}	1(Note 3) 3(Note 4)	W
Operating and Storage Temperature Range	T_j, T_{STG}	-55 to +150	$^\circ\text{C}$

Notes:

- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Device mounted on FR-4 PCB, pad layout as shown on page 4.
- The power which can be dissipated, assuming the device is mounted in a typical manner on a PCB with copper equal to 4 square inch minimum.

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	$V_{(\text{BR})\text{CBO}}$	-100	—	—	V	$I_C = -100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage	$V_{(\text{BR})\text{CEO}}$	-60	—	—	V	$I_C = -10\text{mA}^*, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(\text{BR})\text{EBO}}$	-6	—	—	V	$I_E = -100\mu\text{A}, I_C = 0$
Collector Cutoff Current	I_{CBO}	—	—	-50 -1	nA μA	$V_{\text{CB}} = -80\text{V}, I_E = 0$ $V_{\text{CB}} = -80\text{V}, I_E = 0, T_A = 100^\circ\text{C}$
Emitter Cutoff Current	I_{EBO}	—	—	-10	nA	$V_{\text{EB}} = -6\text{V}, I_C = 0$
ON CHARACTERISTICS						
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{SAT})}$	— — — —	-20 -85 -155 -370	-50 -140 -210 -460	mV	$I_C = -100\text{mA}, I_B = -10\text{mA}^*$ $I_C = -1\text{A}, I_B = -100\text{mA}^*$ $I_C = -2\text{A}, I_B = -200\text{mA}^*$ $I_C = -5\text{A}, I_B = -500\text{mA}^*$
Base-Emitter Saturation Voltage	$V_{\text{BE}(\text{SAT})}$	—	-1080	-1240	mV	$I_C = -5\text{A}, I_B = -500\text{mA}^*$
Base-Emitter Turn-On Voltage	$V_{\text{BE}(\text{ON})}$	—	-935	-1070	mV	$I_{\text{CE}} = -5\text{A}, V_{\text{CE}} = -1\text{V}^*$
DC Current Gain	h_{FE}	100 100 75 10	200 200 90 25	— 300 — —	—	$I_C = -10\text{mA}, V_{\text{CE}} = -1\text{V}^*$ $I_C = -2\text{A}, V_{\text{CE}} = -1\text{V}^*$ $I_C = -5\text{A}, V_{\text{CE}} = -1\text{V}^*$ $I_C = -10\text{A}, V_{\text{CE}} = -1\text{V}^*$
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product	f_T	—	120	—	MHz	$I_C = -100\text{mA}, V_{\text{CE}} = -10\text{V}, f = 50\text{MHz}$
Output Capacitance	C_{obo}	—	74	—	pF	$V_{\text{CB}} = -10\text{V}, f = 1\text{MHz}$
SWITCHING CHARACTERISTICS						
Switching Times	t_{on} t_{off}	—	82 350	—	ns	$I_C = -2\text{A}, I_{B1} = -200\text{mA}$ $I_{B2} = +200\text{mA}, V_{\text{CC}} = -10\text{V}$

* Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤2%

Typical Characteristics @ $T_{\text{amb}} = 25^\circ\text{C}$ unless otherwise specified

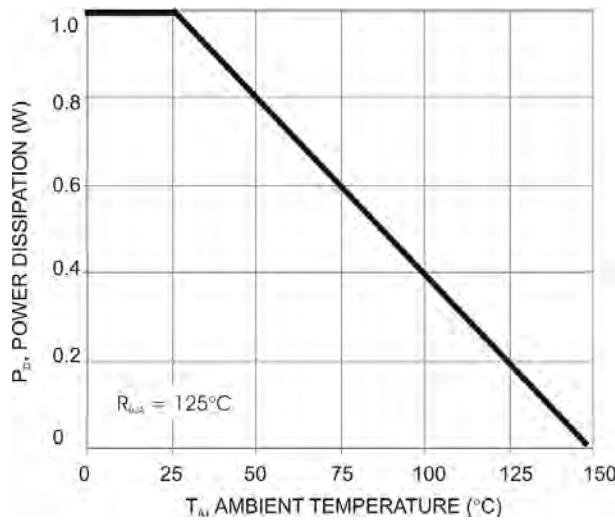


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 3)

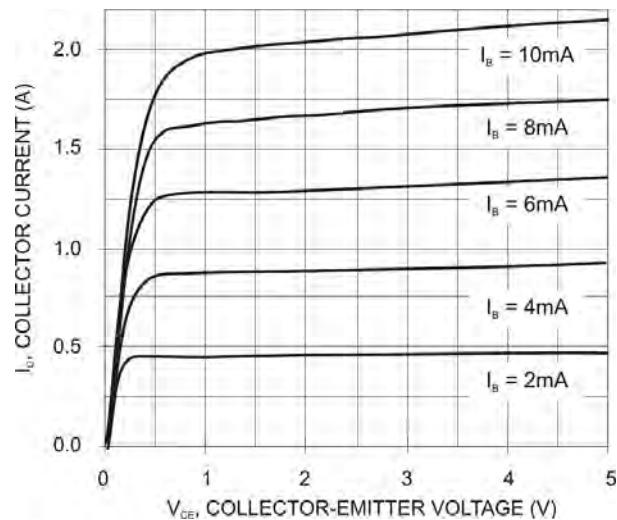


Fig. 2 Collector Current vs. Collector Emitter Voltage

Notes: 3. Device mounted on FR-4 PCB, pad layout as shown on page 4.

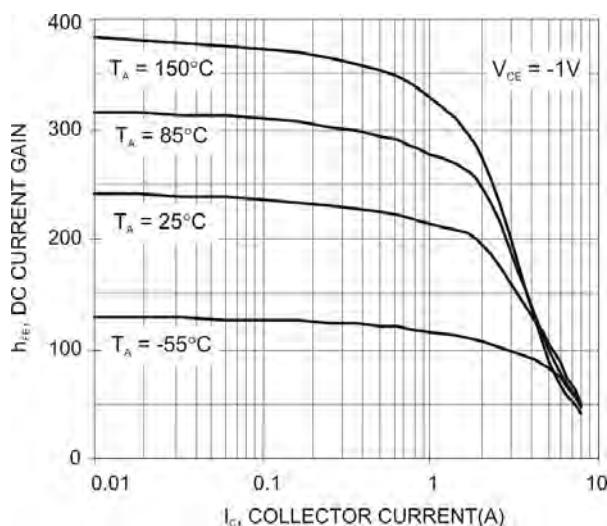


Fig. 3 Typical DC Current Gain vs. Collector Current

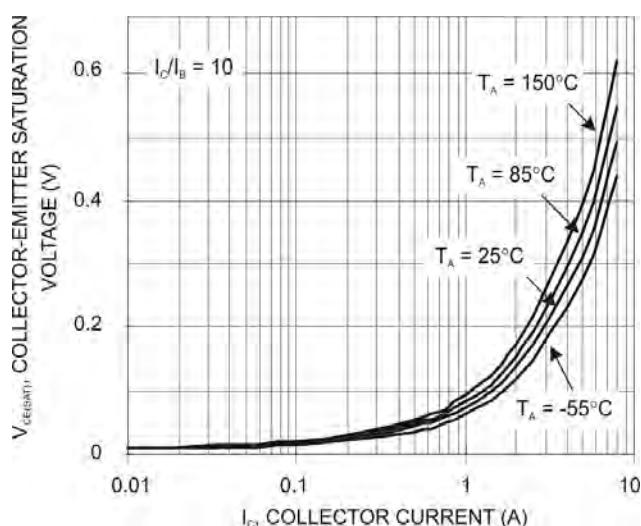


Fig. 4 Collector-Emitter Saturation Voltage vs. Collector Current

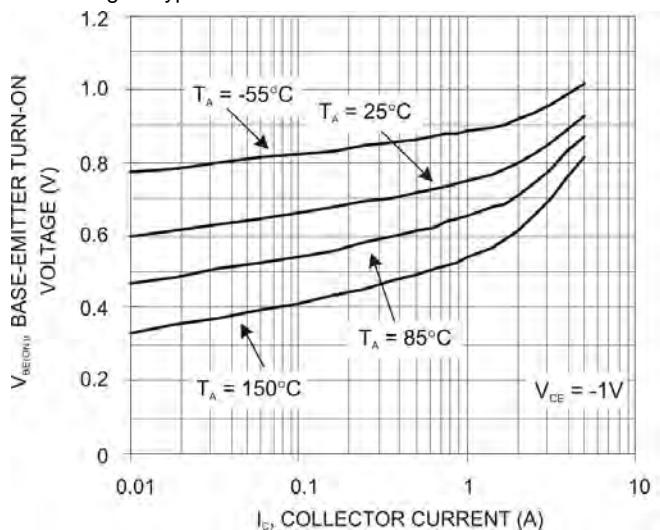


Fig. 5 Base-Emitter Turn-On Voltage vs. Collector Current

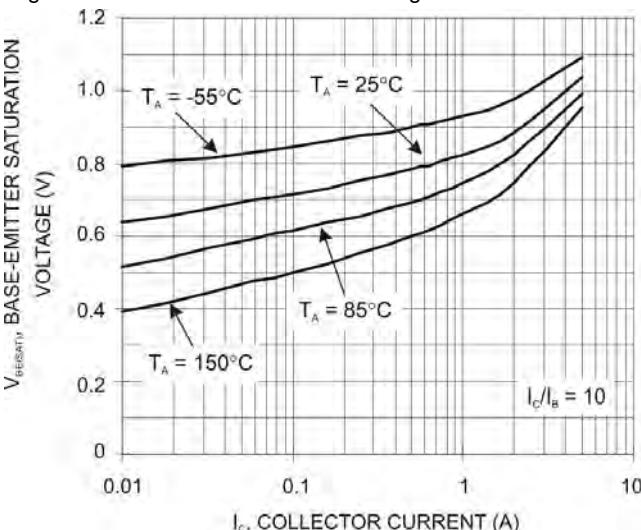


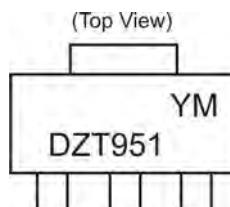
Fig. 6 Base-Emitter Saturation Voltage vs. Collector Current

Ordering Information (Note 5)

Device	Packaging	Shipping
DZT951-13	SOT-223	2500/Tape & Reel

Notes: 5. Packaging Details as shown on page 4, or go to our website at <http://www.diodes.com/ap2007.pdf>.

Marking Information

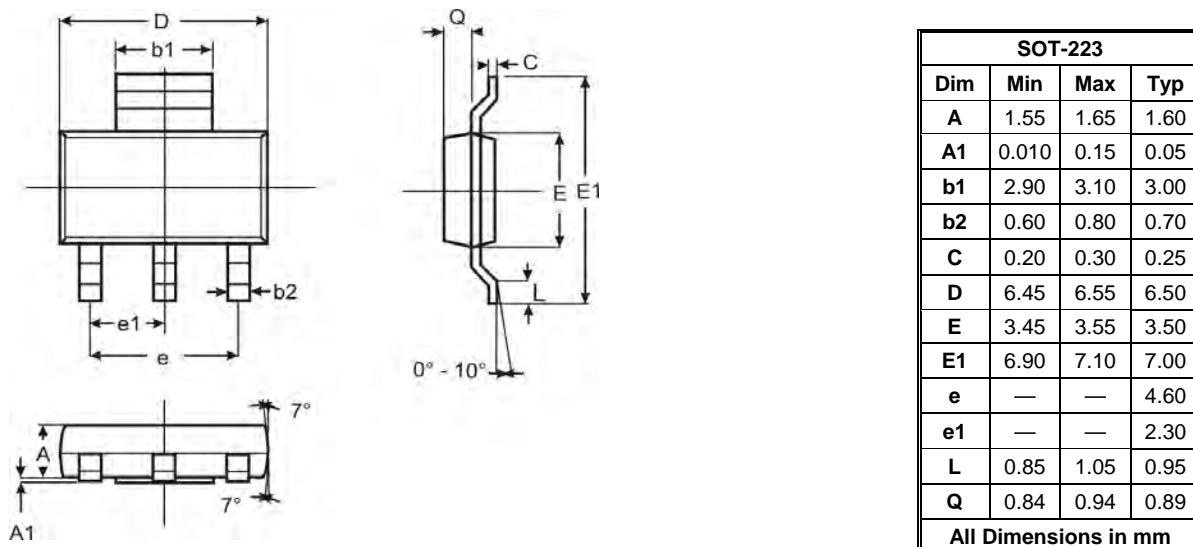


DZT951 = Product Type Marking Code
YM = Date Code Marking
Y = Year ex: T = 2006
M = Month ex: 9 = September

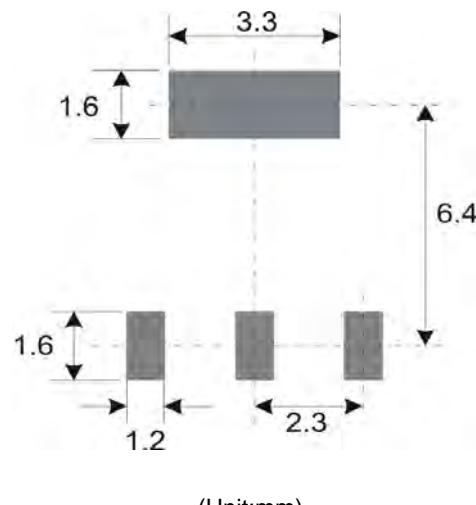
Date Code Key

Year	2006	2007	2008	2009	2010	2011	2012					
Code	T	U	V	W	X	Y	Z					
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



Suggested Pad Layout: (Based on IPC-SM-782)



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